



11-17-03

Attorney Docket No.: A9 DIV 12
Express Mail Label No. EV 322526803 US
Client Matter No: 80741.0008.012

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Tapesh Yadav, et al.

Serial No. 10/679,611

Filed: October 6, 2003

For: PRINTING INKS AND
REAGENTS FOR
NANOELECTRONICS AND
CONSUMER PRODUCTS

Art Unit: Not yet accorded

Examiner: Not yet accorded

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING BY EXPRESS MAIL

Sir:

The undersigned hereby certifies that the attached:

1. Information Disclosure Statement;
2. Form PTO/SB/08A with a copy of 1 reference;
3. Certificate of Mailing; and
4. Return card

relating to the above application, were deposited as "Express Mail" Mailing Label No. EV 322526803 US with the United States Postal Service, addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

11/14/03

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INFORMATION DISCLOSURE STATEMENT
UNDER 37 C.F.R. 1.56

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicant hereby submits for filing under 37 CFR 1.97 a disclosure statement. In submitting these references, no representation is made or implied that the references are or are not material to the examination of this application. The patents, publications or other information of which Applicant is presently aware are listed in Form PTO/SB/08A submitted herewith and 1 copy of non-patent literature is attached hereto.

No fee is believed due for this submittal. However, any fee deficiency associated with this submittal may be charged to Deposit Account No. 50-1123.

Signed on 11/14/03.

Respectfully submitted,


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PTO-1449A (07-01) (Substitute for form 1449A/PTO)		ATTY. DOCKET NO. A9 DIV 12 Client/Matter No. 80168.0340.012	APPLICATION NO. 10/679,611
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use several sheets if necessary) Sheet 1 of 1		FIRST NAMED INVENTOR: Tapesh Yadav	
		FILING DATE October 6, 2003	ART UNIT Not yet accorded

U.S. PATENT DOCUMENTS

Examiner Initials	Cite No.	Document No. No. – Kind Code	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Doc	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
1	6,413,638			Mager et al.	
2	6,467,897			Wu et al.	
3	6,432,526			Arney et al.	
4	6,110,266			Gonzales-Blanco et al.	
5	6,057,637			Zettl et al.	
6	5,764,004			Rabinowitz	

FOREIGN PATENT DOCUMENTS

Examiner Initials	Cite No.	Foreign Patent Doc cntry code – No. – Kind Code	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Doc	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear	TRANSLATION
						YES NO

OTHER PRIOR ART – NON PATENT LITERATURE DOCUMENTS

Examiner Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s) publisher, city and/or country where published
	7	DUAN, et al., "High-performance thin-film transistors using semiconductor nanowires and nanoribbons," J. Nature, Vol. 425, 9/18/2003, pp. 274-178.

EXAMINER SIGNATURE

DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.